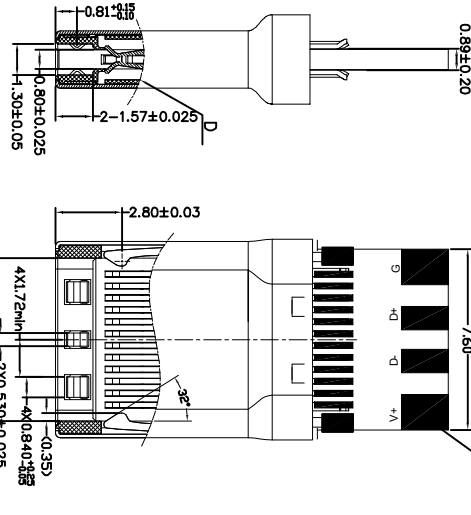
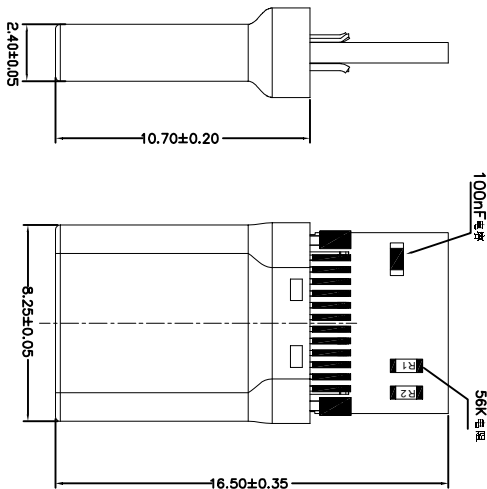
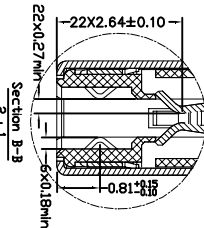
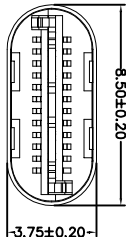


1 2 3 4 5 6 7 8 9 10

Rohs 客户图

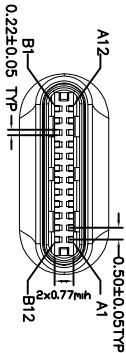
| 目錄<br>MAPX | 設定內容<br>MODIFICATION | 日期<br>DATE |
|------------|----------------------|------------|
| A0         | NEW                  | 09-10-20   |



| Pin Number | host   | device | Pin Number | host   | device |
|------------|--------|--------|------------|--------|--------|
| Pin A1     | GND    | GND    | Pin B12    | GND    | GND    |
| Pin A2     | SSTxp1 | SSTxp1 | Pin B11    | SSRxp1 | SSRxp1 |
| Pin A3     | SSTxp1 | SSTxp1 | Pin B10    | SSRxp1 | SSRxp1 |
| Pin A4     | VBUS   | VBUS   | Pin B9     | VBUS   | VBUS   |
| Pin A5     | ICCI   | ICCI   | Pin B8     | SBu2   | SBu2   |
| Pin A6     | DP1    | DP1    | Pin B7     |        |        |
| Pin A7     | DN1    | DN1    | Pin B6     |        |        |
| Pin A8     | SBu1   | SBu1   | Pin B5     | CC2    | CC2    |
| Pin A9     | VBUS   | VBUS   | Pin B4     | VBUS   | VBUS   |
| Pin A10    | SSRxp2 | SSRxp2 | Pin B3     | SSTxp2 | SSTxp2 |
| Pin A11    | SSRxp2 | SSRxp2 | Pin B2     | SSTxp2 | SSTxp2 |
| Pin A12    | GND    | GND    | Pin B1     | GND    | GND    |

- 备注:
1. 材料: See Table A
  2. 焊接要求: See Table A
  3. 机械性能: See Table A
  4. 电气性能: See Table A
  5. 环境性能: See Table A
  6. 其他性能: See Table A
- 焊接要求: 400W Max (Initial)
- 环境性能: 1000h Min
- 其他性能: 5A for VBUS For A4/A9/B4/B9
1. 25A for Vcc and GND for A1/A2/B1/B5/B12
- 0.25A for all other contacts.
5. 环境性能: 55℃, 48h 外部位置无氧化
- 工作温度: -25℃~80℃
6. 使用物料及制程符合RoHS指令。

|   |           |              |                                                       |
|---|-----------|--------------|-------------------------------------------------------|
| 6 | LATCH     | STAINLESS    | : Ni: 50u"                                            |
| 5 | CONTACT   | COPPER ALLOY | Contact area: 5u", Solder tails: Tin80u", Ni: 30~80u" |
| 4 | molding 2 | L.C.P        | (Black)                                               |
| 3 | GNDSPRING | STAINLESS    |                                                       |
| 2 | Molding   | L.C.P        | (Black)                                               |
| 1 | SHELL     | STAINLESS    | Ni: 50u"                                              |



产品图

深圳市鑫风雷电子有限公司

公差一览表

| 公差一览表                      | 单位          | 单位   | 制图         | 王冠 | 产品料号 | XFLY012-UCAM008-X     |
|----------------------------|-------------|------|------------|----|------|-----------------------|
| TOLERANCE UNLESS OTHERWISE | UNITS       | MM   | DRAWING    | 王冠 | 产品名称 | TYPE C公头拉伸壳C-2数据板焊盘加锡 |
| .XX ±0.30                  | .X' ±5'     | 比例   | 1:1        | 审核 | 雷永健  | PRODUCT NO.           |
| .XX ±0.20                  | .X' ±2'     | 日期   | 2009/10/20 | 核准 | 雷永健  | 角法                    |
| .XXX ±0.15                 | .XXX' ±0.5' | DATE | 2009/10/20 | 核准 | 雷永健  | 版本                    |
|                            |             |      |            |    |      | VER                   |
|                            |             |      |            |    |      | A0                    |